MA3S781F

Silicon epitaxial planar type

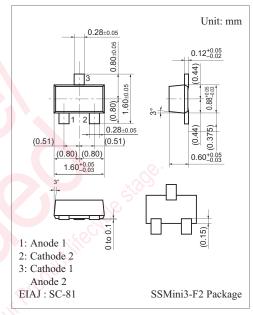
For high speed switching circuits

■ Features

- Optimum for high-density mounting
- $\ ^{\bullet}$ Short reverse recovery time $t_{r\pi}$, optimum for high-frequency rectification

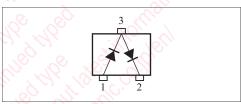
■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit	
Reverse voltage		V_R	30	V	
Maximum peak reverse voltage		V_{RM}	30	V	
Forward current	Single	T	30	mA	
	Series	$I_{\rm F}$	20		
Peak forward current	Single	T	150	mA	
	Series	I_{FM}	110		
Junction temperature		T_{j}	125	°C	
Storage temperature		T _{stg}	-55 to +125	°C	



Marking Symbol: M1U

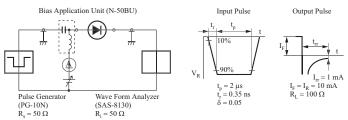
Internal Connection



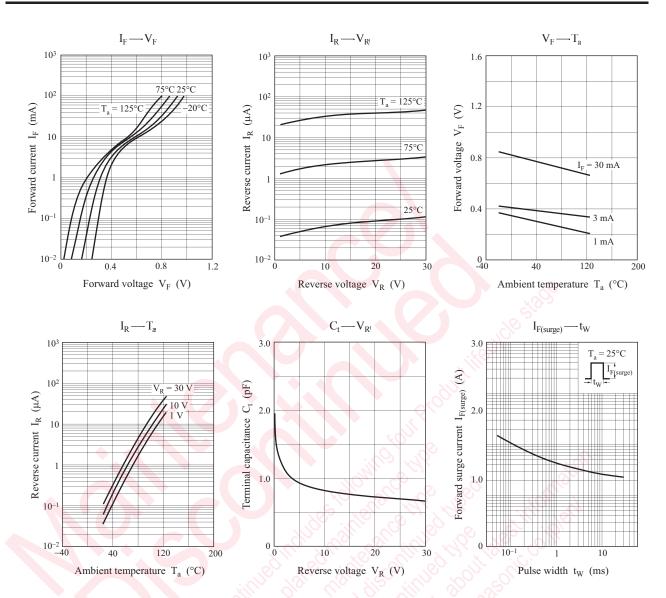
■ Electrical Characteristics $T_a = 25$ °C±3°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{\rm Fl}$	$I_F = 1 \text{ mA}$	60.		0.4	V
	V_{F2}	$I_F = 30 \text{ mA}$			1.0	
Reverse current	I_R	$V_{R} = 30 \text{ V}$			300	nA
Terminal capacitance	C_{t}	$V_{Rl} = 1 \text{ V, } f = 1 \text{ MHz}$		1.5		pF
Reverse recovery time *	t _{rr}	$I_F = I_{Rl} = 10 \text{ mA}, I_{rr} = 1 \text{ mA}$ $R_{Ll} = 100 \Omega$		1.0		ns
Detection efficiency	η	$V_{IN^{J}} = 3 V_{(peak)}, f = 30 \text{ MHz}$ $R_{LJ} = 3.9 \text{ k}\Omega, C_{LJ} = 10 \text{ pF}$		65		%

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - 2. Absolute frequency of input and output is $2\,000\;\text{MHz}$
 - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
 - 3. *: t_{rr} measurement circuit



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